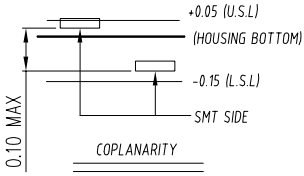
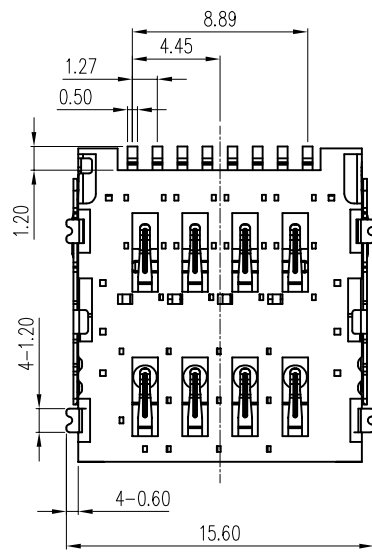
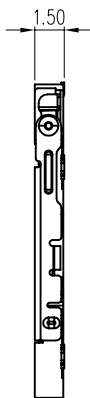
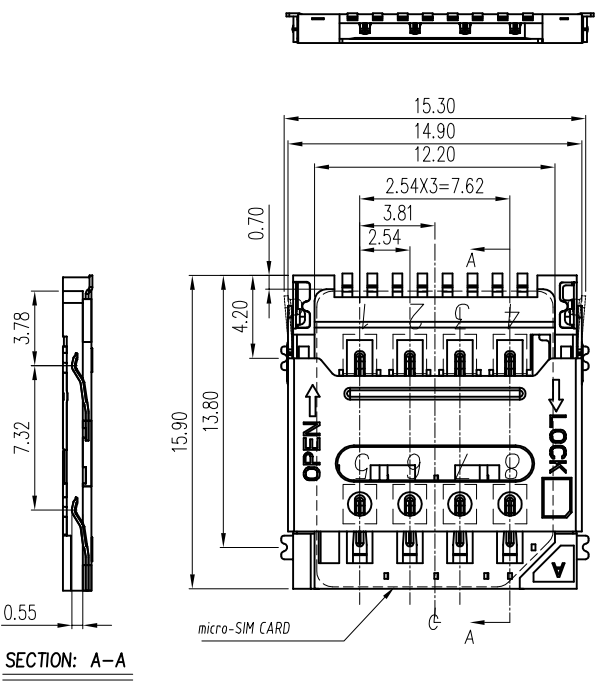


由 Autodesk 教育版产品制作

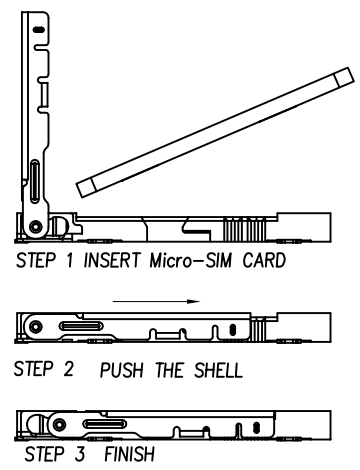
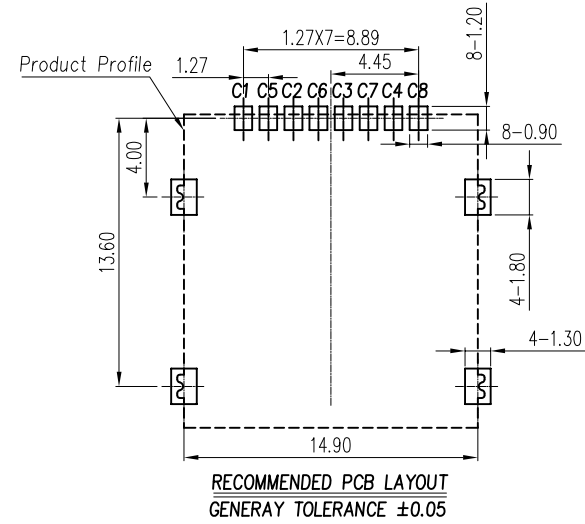
由 Autodesk 教育版产品制作

REV.	ECN NO	DESCRIPTION	DATE	DRAW	APPR
A		NEW			



NOTES:

1. ELECTRICAL CHARACTERISTICS  
1-1. CONTACT RESISTANCE: 60 Milliohms Max  
1-2. INSULATION RESISTANCE: 1,000 Megohms Min.  
1-3. DIELECTRIC WITHSTANDING VOLTAGE: 500V AC FOR 1 MINUTE.
2. MECHANICAL CHARACTERISTICS  
2-1. OPERATION TEMPERATURE RANGE: -25°C~+70°C  
2-2. DURABILITY: 5000 CYCLES
3. MATERIAL:  
3-1. HOUSING: THERMOPLASTIC,UL 94-V0  
3-2. TERMINAL: PHOSPHOR BRONZE,T=0.15  
3-3. SHELL: STAINLESS STEEL,T=0.15
4. FINISHED:  
4-1. TERMINAL: Ni PLATED UNDER,Au PLATED ON CONTACT AREA,G/F PLATED ON SOLDER TAIL



SIM CARD	
Pin No.	NAME
C1	VCC
C2	RST
C3	CLK
C4	RESERVED
C5	GND
C6	VPP
C7	I/O
C8	RESERVED

### Cixi Yexin Electronics Factory

Drawn		Tolerance Unless Otherwise Specified	TITLE: Micro Sim Card Hinge 1. 5H CONN
Checked		.± 0.25 .± 3'	Part No. MSCN08-A0-0150 KF031-FG
Approval		.X± 0.15 .X'± 2'	Sheet: 1/1
		.XX± 0.10 .XX'± 1'	Rev A
		.XXX± 0.05	www.yexin.net